



DIM	MILLIMETERS	
	MIN	MAX
A	0.60 BSC	
B	1.00 BSC	
C	0.45	0.53
D	0.40	0.50
E	0.20	0.275
F	0.10	0.175
G	0.60 BSC	
H	0.00	0.03
J	0.45	0.50
K	0.025 MIN INTERNAL REF	
L	0.30 BSC	
M	0.20	0.275

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MM
- DIMENSION D, E AND H APPLY TO PLATED TERMINALS.

STYLE 1:

- PIN 1. BASE
- EMITTER
- COLLECTOR

STYLE 2:

- PIN 1. ANODE
- N/C
- CATHODE

STYLE 3:

- PIN 1. ANODE
- ANODE
- CATHODE

STYLE 4:

- PIN 1. CATHODE
- CATHODE
- ANODE

CASE NO.	496A-02
STATUS	ON SEMICONDUCTOR STANDARD
NEW STD	
USED ON	1006 MICROLEADLESS 3 PADS



ISSUE	REVISION	COORD/ DATE
0	RELEASED FOR PRODUCTION. REQ. BY K. KIME	FB 14 DEC 01
A	ADDED BASIC REFERENCE TO DIM A, B, G AND L. DIM D MAX WAS: 0.45 DIM E MAX WAS: 0.25. DIM E1 MAX WAS: 0.25. DIM F MAX WAS: 0.15. DIM K WAS: 0.05 REF. DELETED INCH DIMENSIONS.	ME 17 DEC 2002